

## DECLARATION AND POWER OF ATTORNEY FOR U.S. PATENT APPLICATION

(X) Original ( ) Supplemental ( ) Substitute ( ) PCT ( ) DESIGN

As a below named inventor, I hereby declare that: my residence, post office address and citizenship are as stated below next to my name; that I verily believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural inventors are named below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

Title: EXTERNAL PREPARATION FOR WOUNDS

of which is described and claimed in:

( ) the attached specification, or

( ) the specification in application Serial No. \_\_\_\_\_, filed \_\_\_\_\_, and with amendments

through \_\_\_\_\_, or

(X) the specification in International Application No. PCT/JP03/02887, filed March 12, 2003,

and as amended on \_\_\_\_\_ (if applicable).

I hereby state that I have reviewed and understand the content of the above-identified specification, including the claims, as amended by any amendment(s) referred to above.

I acknowledge my duty to disclose to the Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, §1.56.

I hereby claim priority benefits under Title 35, United States Code, §119 (and §172 if this application is for a Design) of any application(s) for patent or inventor's certificate listed below and have also identified below any application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

COUNTRY	APPLICATION NO.	DATE OF FILING	PRIORITY CLAIMED
Japan	2002-069901	March 14, 2002	Yes
Japan	2002-120084	April 23, 2002	Yes
Japan	2002-189912	June 28, 2002	Yes

I hereby claim the benefit under Title 35, United States Code §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code §112, I acknowledge the duty to disclose information material to patentability as defined in Title 37, Code of Federal Regulations, §1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

APPLICATION SERIAL NO.	U.S. FILING DATE	STATUS: PATENTED, PENDING, ABANDONED

And I hereby appoint all attorneys and agents of WENDEROTH, LIND & PONACK, L.L.P., associated with Customer No. 00513, to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith.



I hereby authorize the U.S. attorneys and agents named herein to accept and follow instructions from

as to any action to be taken in the U.S. Patent and Trademark Office regarding this application without direct communication between the U.S. attorneys and myself. In the event of a change in the persons from whom instructions may be taken, the U.S. attorneys named herein will be so notified by me.

Direct Correspondence to:		Direct Telephone Calls to:	
<p>CUSTOMER NO.</p> <p><b>00513</b></p>		<p>WENDEROTH, LIND &amp; PONACK, L.L.P.</p> <p>1030 15<sup>th</sup> Street, N.W., Suite 400 East</p> <p>Washington, D.C. 20005-1503</p> <p>Phone:(202) 721-8200</p> <p>Fax:(202) 721-8250</p>	
Full Name of First Inventor	FAMILY NAME <b>HAMAMOTO</b>	FIRST GIVEN NAME <b>HIDETOSHI</b>	SECOND GIVEN NAME
Residence & Citizenship	CITY <b>Kitajima-cho, Japan</b>	STATE OR COUNTRY <b>Japan</b>	COUNTRY OF CITIZENSHIP <b>Japan</b>
Post Office Address	ADDRESS <b>40-24, Aza Nakasao, Shinkirai, Kitajima-cho, Itano-gun, Tokushima, Japan</b>	CITY	STATE OR COUNTRY ZIP CODE
Full Name of Second Inventor	FAMILY NAME <b>YAMASAKI</b>	FIRST GIVEN NAME <b>Keiko</b>	SECOND GIVEN NAME
Residence & Citizenship	CITY <b>Higashikagawa-shi, Japan</b>	STATE OR COUNTRY <b>Japan</b>	COUNTRY OF CITIZENSHIP <b>Japan</b>
Post Office Address	ADDRESS <b>313-31, Machida, Higashikagawa-shi, Kagawa, Japan</b>	CITY	STATE OR COUNTRY ZIP CODE
Full Name of Third Inventor	FAMILY NAME <b>YOKOYAMA</b>	FIRST GIVEN NAME <b>Hideakira</b>	SECOND GIVEN NAME
Residence & Citizenship	CITY <b>Tokushima-shi, Japan</b>	STATE OR COUNTRY <b>Japan</b>	COUNTRY OF CITIZENSHIP <b>Japan</b>
Post Office Address	ADDRESS <b>1-12-5-103, Suehiro 5-chome, Tokushima-shi, Tokushima, Japan</b>	CITY	STATE OR COUNTRY ZIP CODE
Full Name of Fourth Inventor	FAMILY NAME <b>HIRATA</b>	FIRST GIVEN NAME <b>Akihiko</b>	SECOND GIVEN NAME
Residence & Citizenship	CITY <b>Naruto-shi, Japan</b>	STATE OR COUNTRY <b>Japan</b>	COUNTRY OF CITIZENSHIP <b>Japan</b>
Post Office Address	ADDRESS <b>87-302, Aza Motochi, Tateiwa, Muyacho, Naruto-shi, Tokushima, Japan</b>	CITY	STATE OR COUNTRY ZIP CODE

Full Name of Fifth Inventor	FAMILY NAME FUJII	FIRST GIVEN NAME Takeru	SECOND GIVEN NAME
Residence & Citizenship	CITY Naruto-shi, Japan	STATE OR COUNTRY Japan	COUNTRY OF CITIZENSHIP Japan
Post Office Address	ADDRESS 446, Aza Minami, Takeshima, Narutocho, Naruto-shi, Tokushima, Japan	CITY Naruto-shi, Japan	STATE OR COUNTRY Japan

I further declare that all statements made herein of my own knowledge are true, and that all statements on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

1<sup>st</sup> Inventor \_\_\_\_\_ Date \_\_\_\_\_

2<sup>nd</sup> Inventor Keiko Yamasaki Date April 12, 2010

3<sup>rd</sup> Inventor \_\_\_\_\_ Date \_\_\_\_\_

4<sup>th</sup> Inventor \_\_\_\_\_ Date \_\_\_\_\_

5<sup>th</sup> Inventor \_\_\_\_\_ Date \_\_\_\_\_

The above application may be more particularly identified as follows:

U.S. Application Serial No. \_\_\_\_\_ Filing Date \_\_\_\_\_

Applicant Reference Number \_\_\_\_\_ Atty Docket No. \_\_\_\_\_

Title of Invention

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